



#### 40V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

#### **Product Summary**

BV <sub>DSS</sub>	Rds(on) max	I <sub>D</sub> Tc = +25°C
-40V	5.2mΩ @ V <sub>GS</sub> = -10V	-115A
	7.9mΩ @ V <sub>GS</sub> = -6V	-94A

### **Description and Applications**

This new generation MOSFET has been designed to minimize the onstate resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Reverse Polarity Protection
- BLDC Motor Control
- Power Management Functions
- System/Load Switch

#### **Features and Benefits**

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspections
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e.: parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please refer to the related automotive grade (Q-suffix) part. A listing can be found at

https://www.diodes.com/products/automotive/automotive-products/.

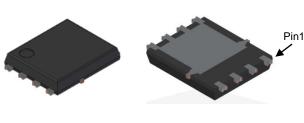
 This part is qualified to JEDEC standards (as references in AEC-Q) for High Reliability.

https://www.diodes.com/quality/product-definitions/

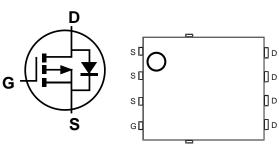
#### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe;
  Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

PowerDI5060-8 (SWP) (Type UX)



Top View Bottom View



Internal Schematic Top View Pin Configuration

### **Ordering Information** (Note 4)

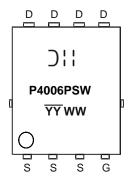
Part Number	Case	Packaging
DMP4006SPSW-13	PowerDI5060-8 (SWP) (Type UX)	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/



# **Marking Information**



YY= Year (ex: 21 = 2021) WW = Week (01 to 53)

# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			$V_{DSS}$	-40	V
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	ΙD	-115 -92	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	-460	Α		
Maximum Body Diode Continuous Current			Is	-115	Α
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)			lsм	-460	Α
Avalanche Current (L =0.1mH)			las	-72	Α
Avalanche Energy (L = 0.1mH)			E <sub>AS</sub>	262	mJ

# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	$P_{D}$	3.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	36.5	°C/W
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		PD	104	W
Thermal Resistance, Junction to Case (Note 6)	Reлc	1.2	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad). Notes:



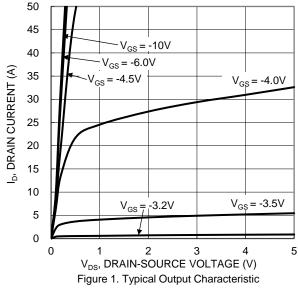
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

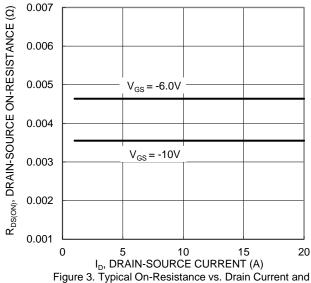
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	٧	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS		_	-1	μΑ	$V_{DS} = -40V$ , $V_{GS} = 0V$	
Gate-Source Leakage	IGSS		_	±100	nA	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	-2.0	_	-3.0	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Pro/our		3.6	5.2	mΩ	$V_{GS} = -10V, I_{D} = -9.8A$	
Static Diain-Source On-Resistance	RDS(ON)		4.5	7.9	1112.2	$V_{GS} = -6V, I_{D} = -9.8A$	
Diode Forward Voltage	$V_{SD}$		-0.7	-1	V	$V_{GS} = 0V$ , $I_S = -1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		6855	_			
Output Capacitance	Coss	_	883	_	pF	$V_{DS} = -20V$ , $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	Crss	_	526	_			
Gate Resistance	Rg	_	7.8	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = -10V)	Qg		162	_			
Gate-Source Charge	Qgs		28	_	nC	$V_{DS} = -20V, I_{D} = -9.8A$	
Gate-Drain Charge	$Q_{gd}$	_	38	_			
Turn-On Delay Time	td(ON)	_	28	_			
Turn-On Rise Time	tR	_	32	_		Vgs = -10V, Vdd = -20V,	
Turn-Off Delay Time	tD(OFF)	1	469	_	ns	$R_G = 6\Omega$ , $I_D = -9.8A$	
Turn-Off Fall Time	tF	_	228	_			
Reverse Recovery Time	t <sub>RR</sub>		44	_	ns	I <sub>F</sub> = -9.8A, di/dt = -100A/µs	
Reverse Recovery Charge	Q <sub>RR</sub>		48	_	nC	IF = -9.8A, di/dt = -100A/µs	

Notes: 7. Short duration pulse test used to minimize self-heating effect.

<sup>8.</sup> Guaranteed by design. Not subject to product testing.







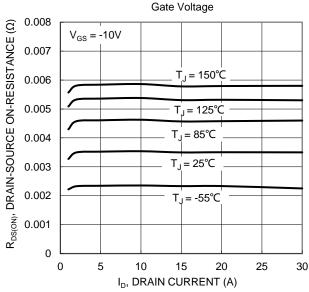
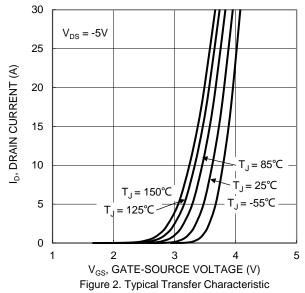
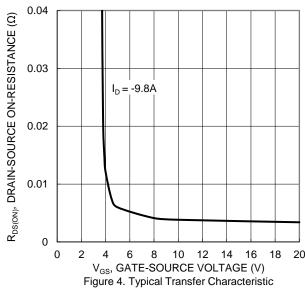


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





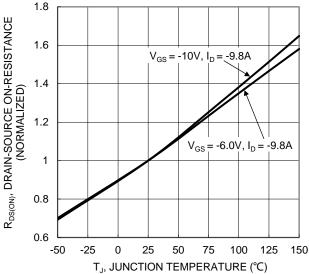


Figure 6. On-Resistance Variation with Junction Temperature



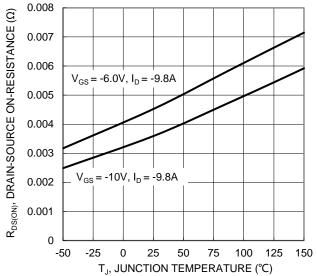
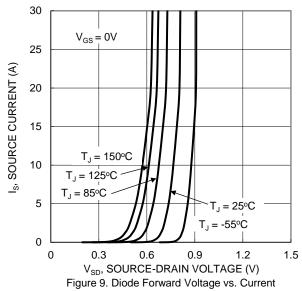


Figure 7. On-Resistance Variation with Junction Temperature



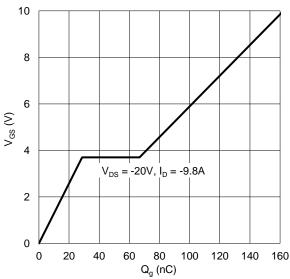


Figure 11. Gate Charge

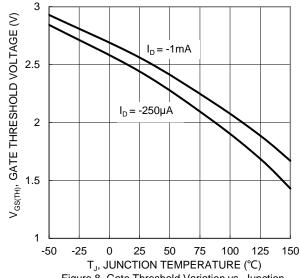
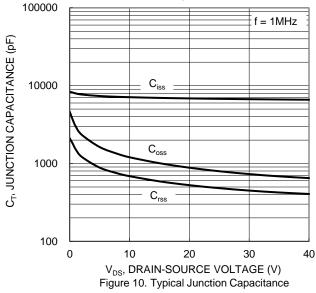
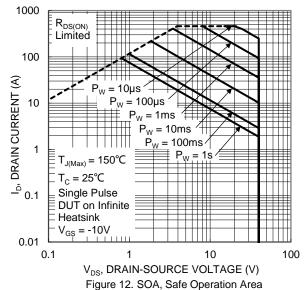


Figure 8. Gate Threshold Variation vs. Junction Temperature







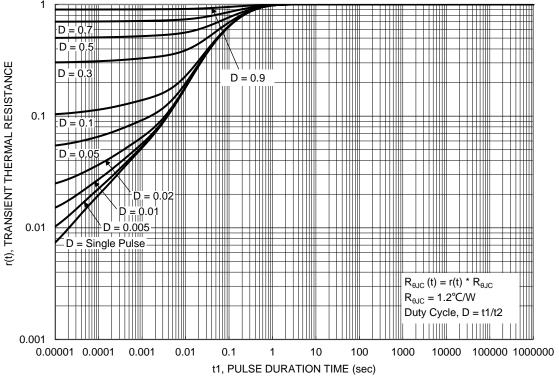


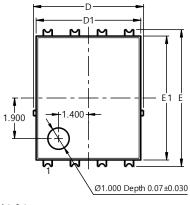
Figure 13. Transient Thermal Resistance

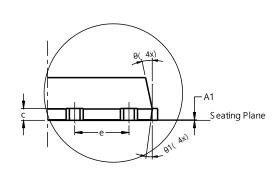


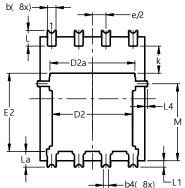
# **Package Outline Dimensions**

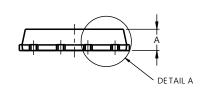
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8 (SWP) (Type UX)









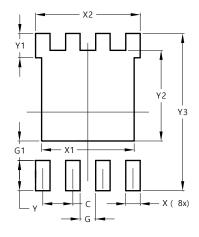
DETAIL A

PowerDI5060-8 (SWP) (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
A1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	(	).25REF		
С	0.230	0.330	0.277	
D		.15 BS0	2	
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78 4.18 3.98		3.98	
Е	6.40 BSC			
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1.27BSC			
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L1a	0.050REF			
L4	0.025	0.225	0.125	
M	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value		
Dillielisions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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